

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ADVANCED POWER DEVICE RESEARCH ASSOCIATION	02/07/2014
RECEIVING PARTY DATA	
Name:	TOHOKU UNIVERSITY
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City:	SENDAI-SHI, MIYAGI
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13582239
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ATTORNEY DOCKET NUMBER:	5421-001
NAME OF SUBMITTER:	BENJAMIN J. HAUPTMAN
Signature:	/Benjamin J. Hauptman/
Date:	02/07/2014
Total Attachments: 1 source=Company_to_Company_Assignment#page1.tif	

Docket No.: 5421-001

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

ADVANCED POWER DEVICE RESEARCH ASSOCIATION

the owner of the invention by virtue of an Assignment recorded in the U.S. Patent Office on **October 18, 2012**, at **Reel/Frame No.: 029151/0799**, hereby sells, assigns and transfers unto

TOHOKU UNIVERSITY

having a business at:

2-1-1, KATAHIRA, AOBA-KU, SENDAI-SHI, MIYAGI, JAPAN 9808577

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled:

METHOD OF PRODUCING SEMICONDUCTOR TRANSISTOR

- (a) for which an application for United States Letters Patent is identified by United States Patent **Application No. 13/582,239**; or
- (b) for which an application for United States Letters Patent was executed on _____,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all extensions, divisions, reissues, or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:


Name: Kazunori NAKAMURA

FEB. 7, 2014
Date:

Title: President